

CS2D, CS2G, CS2J, CS2K, CS2M

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Vishay General Semiconductor

Surface Mount Glass Passivated Rectifier



SMB (DO-214AA)

DESIGN SUPPORT TOOLS

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PRIMARY CHARACTERISTICS					
I _{F(AV)}	2.0 A				
V_{RRM}	200 V, 400 V, 600 V, 800 V, 1000 V				
I _{FSM}	50 A				
I _R	5.0 μΑ				
V_F at $I_F = 2.0$ A $(T_A = 125 ^{\circ}C)$	0.90 V				
T _J max.	150 °C				
Package	SMB (DO-214AA)				
Circuit configuration	Single				

FEATURES

- · Low profile package
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

MECHANICAL DATA

Case: SMB (DO-214AA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	CS2D	CS2G	CS2J	CS2K	CS2M	UNIT
Device marking code		D	G	J	K	М	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Average forward rectified current	I _{F(AV)} (1)	1.6					
	I _{F(AV)} (2)	2.0					A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50			А		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150				°C	

Notes

- (1) Free air, mounted on recommended copper pad area
- (2) Mounted on 8 mm x 8 mm copper pad areas

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT		
Maximum instantaneous forward voltage	I _F = 1.0 A	T 05.00		0.92	-			
	I _F = 2.0 A T _A = 25 °C	V _E (1)	0.99	1.2	V			
	I _F = 1.0 A	T _A = 125 °C	V _F ('')	0.81	-	V		
	I _F = 2.0 A			0.90	0.98			
Maximum DC reverse current at rated DC blocking voltage	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5.0	μΑ		
	nateu v _R	T _A = 125 °C		-	350			
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$		t _{rr}	2.1	-	μs		
Typical junction capacitance	4.0 V, 1 MHz		CJ	12	-	pF		

Notes

- (1) Pulse test: 300 µs pulse width, 1 % duty cycle
- (2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	CS2D	CS2G	CS2J	CS2K	CS2M	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	97					°C/W
Typical trieffilal resistance	R _{0JM} (2)	20					5/44

Notes

- $^{(1)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction-to-ambient
- $^{(2)}$ Mounted on 8 mm x 8 mm copper pad areas, $R_{\theta JM}$ junction-to-mount at the terminal

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
CS2J-E3/I	0.096	I	3200	13" diameter plastic tape and reel			

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

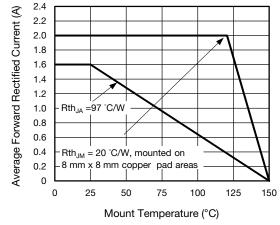


Fig. 1 - Maximum Forward Current Derating Curve

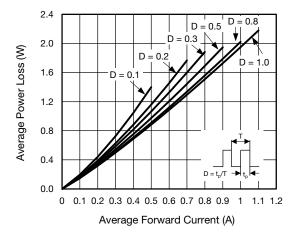


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

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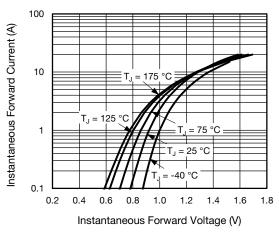


Fig. 3 - Typical Instantaneous Forward Characteristics

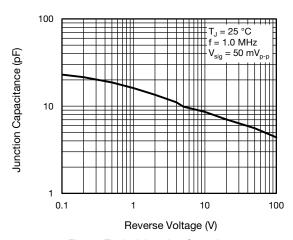


Fig. 5 - Typical Junction Capacitance

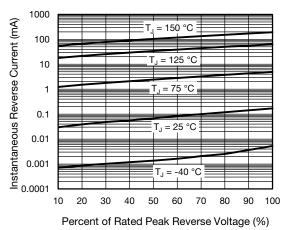


Fig. 4 - Typical Reverse Leakage Characteristics

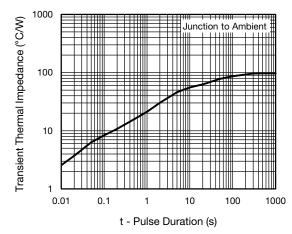
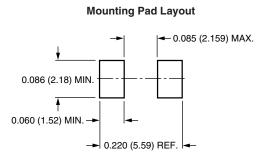


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMB (DO-214AA) Cathode Band 0.086 (2.20) 0.155 (3.94) 0.077 (1.95) 0.130 (3.30) 0.180 (4.57) 0.160 (4.06) 0.012 (0.305) 0.006 (0.152) 0.096 (2.44) 0.060 (1.52) 0.008 (0.2) 0.030 (0.76) 0(0)0.220 (5.59) 0.205 (5.21)



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